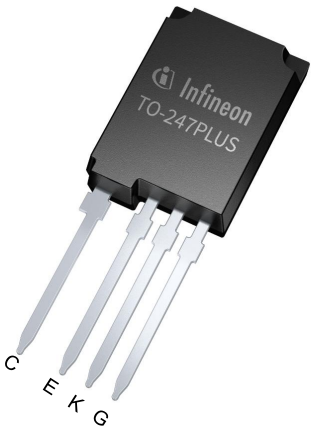
High speed 1200 V TRENCHSTOP™ IGBT 7 Technology co-packed with full rated current, soft-commutating, ultra-fast recovery and low Qrr emitter controlled 7 Rapid diode

Features

- V_{CE} = 1200 V
- I_C = 140 A
- Maximum junction temperature T_{vjmax} = 175°C
- Best-in-class high speed IGBT co-packed with full rated current, low Q_{rr} and soft-commutating high speed diode
- Low saturation voltage V_{CEsat} = 1.7 V at T_{vj} = 25°C
- Optimized for high efficiency in high speed hard switching topologies (2-L inverter, 3-L NPC T-type, ...)
- Easy paralleling capability due to positive temperature coefficient in V_{CEsat}
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: http://www.infineon.com/igbt/



Lead-free
Green
Halogen-free
RoHS

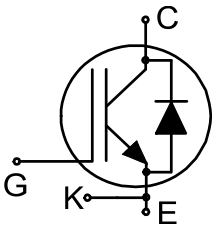
Potential applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description



Type	Package	Marking
IKY140N120CH7	PG-TO247-4-PLUS-NN5.1	K140MCH7

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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.12	0.16	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.21	0.27	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25$ °C		1200	V
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25$ °C	232	A
			$T_c = 100$ °C	193	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			560	A
Turn-off safe operating area		$V_{CC} \leq 800$ V, $V_{CE,peak} < 1200$ V, $V_{GE} = 0/15$ V, $R_{Goff} \geq 8.2\ \Omega$, $T_{vj} \leq 175$ °C		560	A
Gate-emitter voltage	V_{GE}			±20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 0.5$ µs, $D < 0.001$		±25	V
Power dissipation	P_{tot}		$T_c = 25$ °C	962	W
			$T_c = 100$ °C	481	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 140$ A, $V_{GE} = 15$ V	$T_{vj} = 25$ °C		1.7	2.15	V
			$T_{vj} = 175$ °C		2		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Gate-emitter threshold voltage	V_{GEth}	I_C = 2.24 mA, V_{CE} = V_{GE}		4.7	5.5	6.2	V
Zero gate-voltage collector current	I_{CES}	V_{CE} = 1200 V, V_{GE} = 0 V	T_{vj} = 25 °C			40	µA
			T_{vj} = 175 °C		17500		
Gate-emitter leakage current	I_{GES}	V_{CE} = 0 V, V_{GE} = 20 V				100	nA
Transconductance	g_{fs}	I_C = 140 A, V_{CE} = 20 V			344		S
Input capacitance	C_{ies}	V_{CE} = 25 V, V_{GE} = 0 V, f = 100 kHz			18.5		nF
Output capacitance	C_{oes}	V_{CE} = 25 V, V_{GE} = 0 V, f = 100 kHz			317		pF
Reverse transfer capacitance	C_{res}	V_{CE} = 25 V, V_{GE} = 0 V, f = 100 kHz			94		pF
Gate charge	Q_G	V_{CC} = 960 V, I_C = 140 A, V_{GE} = 15 V			1032		nC
Turn-on delay time	$t_{d(on)}$	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		50		ns
			T_{vj} = 175 °C, I_C = 140 A		48		
Rise time (inductive load)	t_r	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		20		ns
			T_{vj} = 175 °C, I_C = 140 A		23		
Turn-off delay time	$t_{d(off)}$	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		407		ns
			T_{vj} = 175 °C, I_C = 140 A		504		
Fall time (inductive load)	t_f	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		37		ns
			T_{vj} = 175 °C, I_C = 140 A		123		
Turn-on energy	E_{on}	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		2.64		mJ
			T_{vj} = 175 °C, I_C = 140 A		4.42		
Turn-off energy	E_{off}	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		3.9		mJ
			T_{vj} = 175 °C, I_C = 140 A		8.45		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Total switching energy	E_{ts}	V_{CC} = 600 V, V_{GE} = 0/15 V, $R_{G(on)}$ = 2.9 Ω, $R_{G(off)}$ = 2.9 Ω	T_{vj} = 25 °C, I_C = 140 A		6.54		mJ
			T_{vj} = 175 °C, I_C = 140 A		12.9		
Operating junction temperature	T_{vj}			-40		175	°C

Note: Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	T_c = 25 °C	170	A
			T_c = 91 °C	140	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}			560	A
Power dissipation	P_{tot}		T_c = 25 °C	549	W
			T_c = 100 °C	275	

Table 5 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode forward voltage	V_F	I_F = 140 A	T_{vj} = 25 °C		2.5	3	V
			T_{vj} = 175 °C		2.3		
Diode reverse recovery time	t_{rr}	V_R = 600 V, $R_{G(on)}$ = 2.9 Ω	T_{vj} = 25 °C, I_F = 140 A		101		ns
			T_{vj} = 175 °C, I_F = 140 A		187		
Diode reverse recovery charge	Q_{rr}	V_R = 600 V, $R_{G(on)}$ = 2.9 Ω	T_{vj} = 25 °C, I_F = 140 A		4.14		µC
			T_{vj} = 175 °C, I_F = 140 A		13.9		
Diode peak reverse recovery current	I_{rrm}	V_R = 600 V, $R_{G(on)}$ = 2.9 Ω	T_{vj} = 25 °C, I_F = 140 A		116		A
			T_{vj} = 175 °C, I_F = 140 A		216		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	V_R = 600 V, $R_{G(on)}$ = 2.9 Ω	T_{vj} = 25 °C, I_F = 140 A		-3140		A/µs
			T_{vj} = 175 °C, I_F = 140 A		-4600		
Reverse recovery energy	E_{rec}	V_R = 600 V, $R_{G(on)}$ = 2.9 Ω	T_{vj} = 25 °C, I_F = 140 A		1.83		mJ
			T_{vj} = 175 °C, I_F = 140 A		6.2		
Operating junction temperature	T_{vj}			-40		175	°C

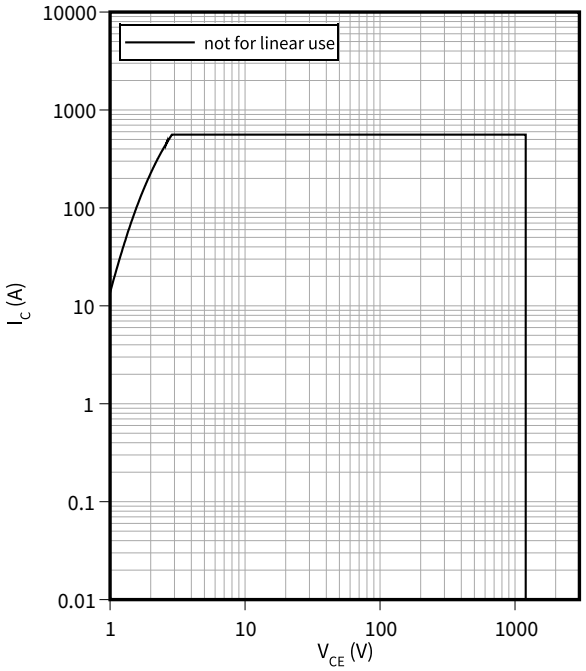
Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Dynamic test circuit, parasitic inductance L_σ = 30 nH, C_σ = 18 pF

4 Characteristics diagrams

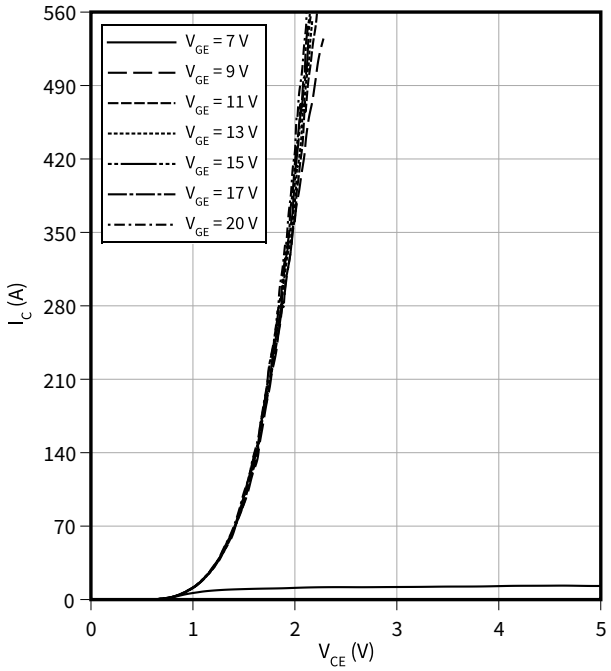
Reverse bias safe operating area

$I_C = f(V_{CE})$, $I_C = f(V_{CE})$
$T_{vj} \leq 175$ °C, $V_{GE} = 0/15$ V



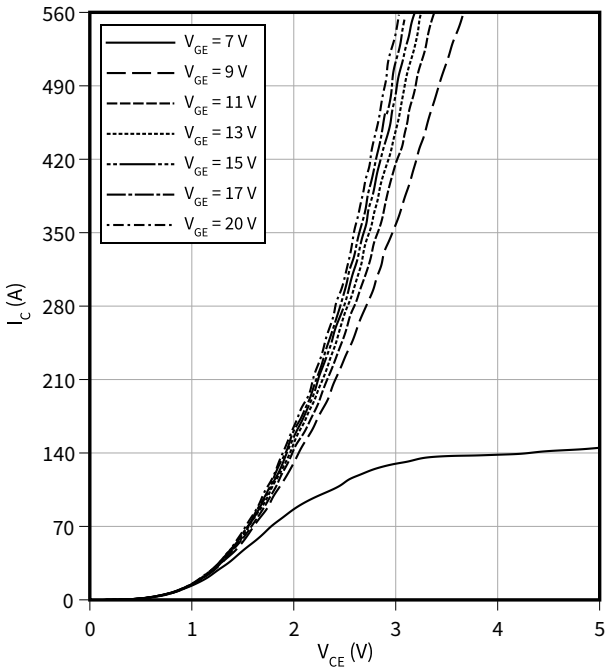
Typical output characteristic

$I_C = f(V_{CE})$
$T_{vj} = 25$ °C



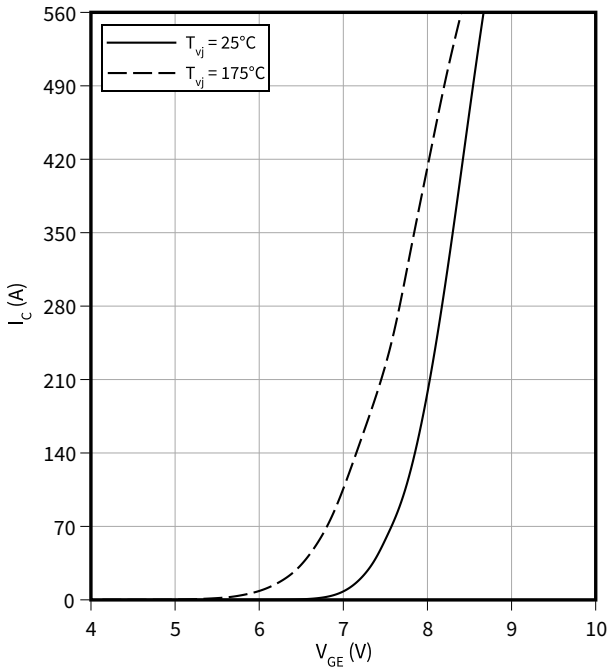
Typical output characteristic

$I_C = f(V_{CE})$
$T_{vj} = 175$ °C



Typical transfer characteristic

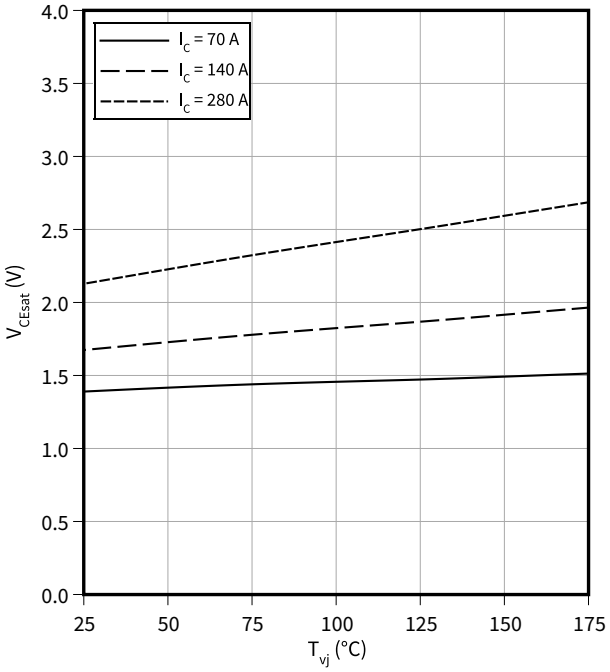
$I_C = f(V_{GE})$
$V_{CE} = 20$ V



Typical collector-emitter saturation voltage as a function of junction temperature

$V_{CEsat} = f(T_{vj})$

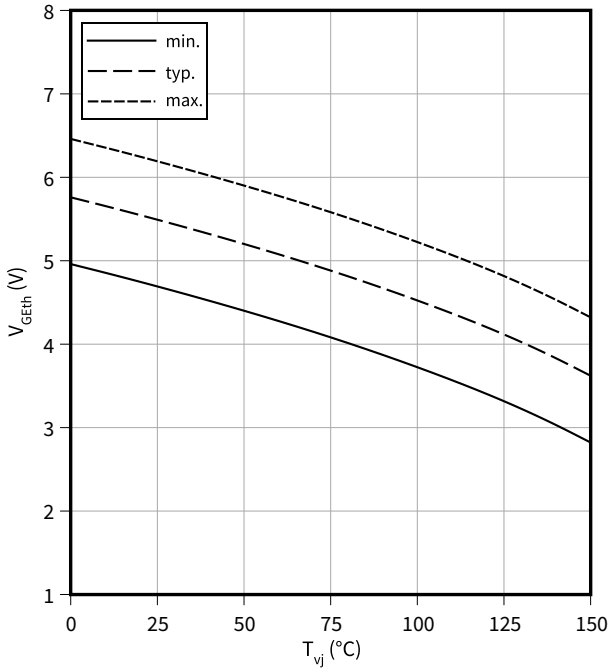
$V_{GE} = 15$ V



Gate-emitter threshold voltage as a function of junction temperature

$V_{GEth} = f(T_{vj})$

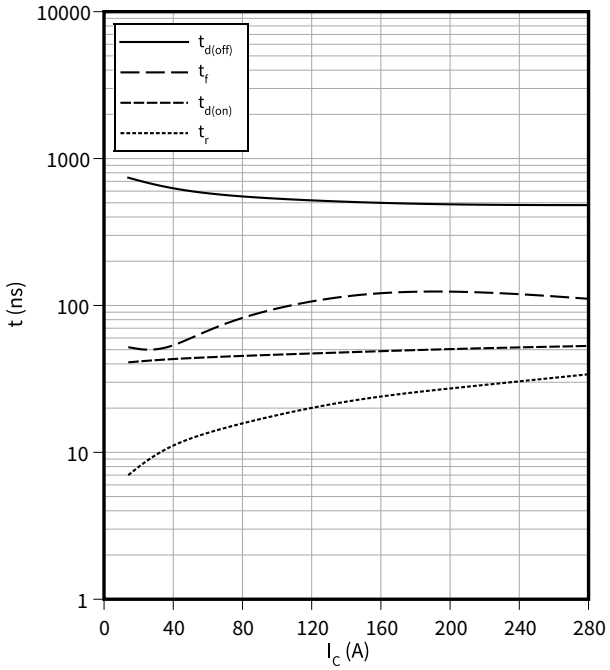
$I_C = 2.24$ mA



Typical switching times as a function of collector current

$t = f(I_C)$

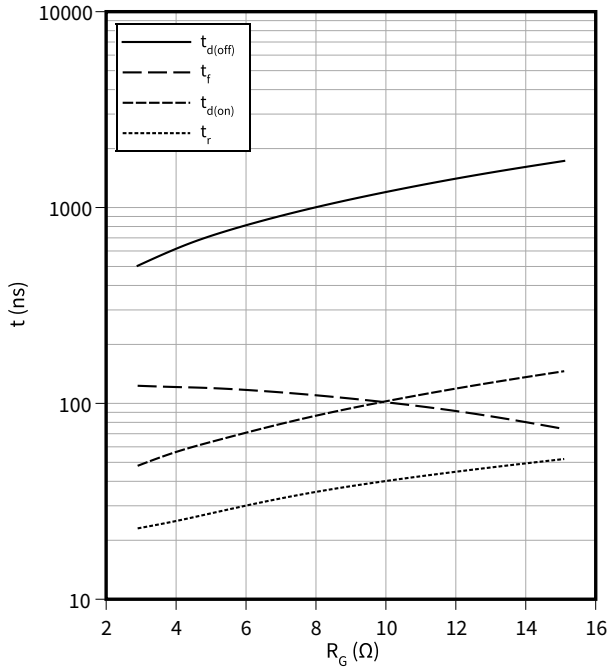
$V_{CC} = 600$ V, $T_{vj} = 175$ °C, $V_{GE} = 0/15$ V, $R_G = 2.9$ Ω



Typical switching times as a function of gate resistor

$t = f(R_G)$

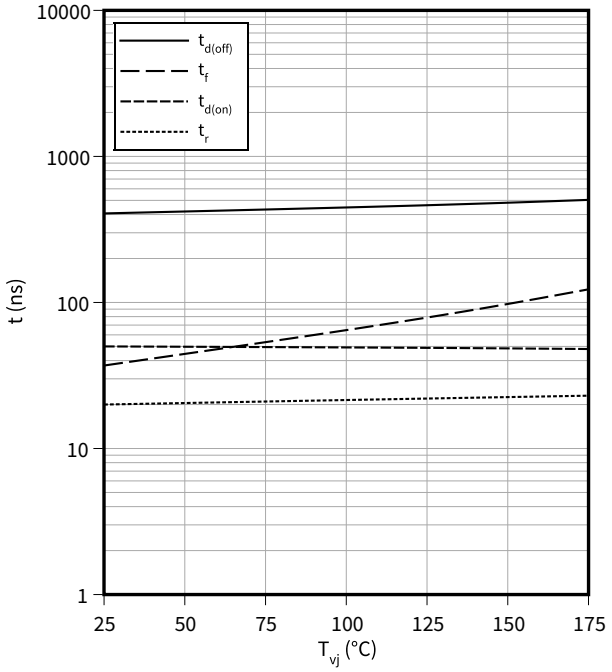
$I_C = 140$ A, $V_{CC} = 600$ V, $T_{vj} = 175$ °C, $V_{GE} = 0/15$ V



Typical switching times as a function of junction temperature

$t = f(T_{vj})$

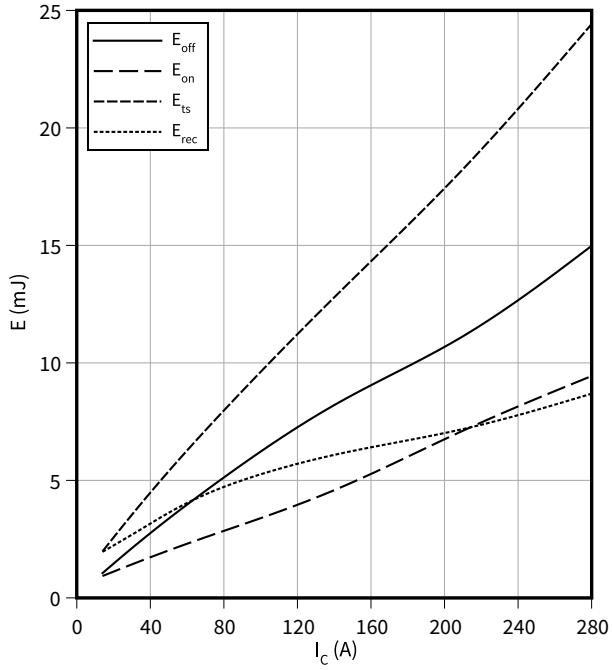
I_C = 140 A, V_{CC} = 600 V, V_{GE} = 0/15 V, R_G = 2.9 Ω



Typical switching energy losses as a function of collector current

$E = f(I_C)$

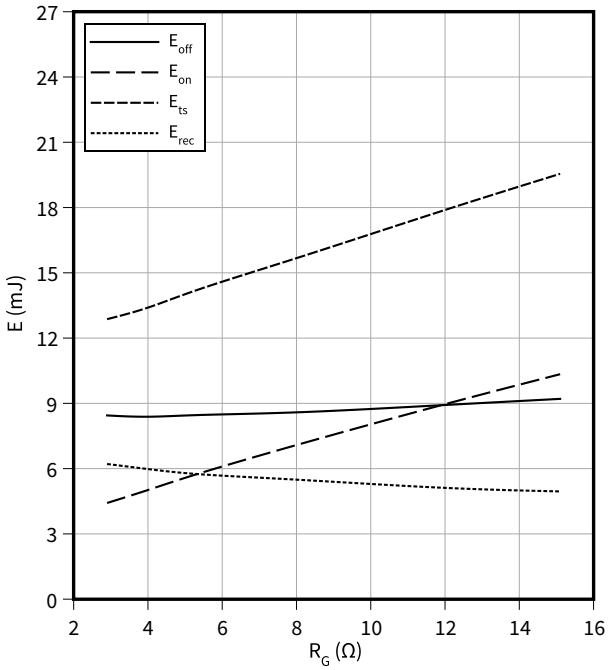
V_{CC} = 600 V, T_{vj} = 175 °C, V_{GE} = 0/15 V, R_G = 2.9 Ω



Typical switching energy losses as a function of gate resistor

$E = f(R_G)$

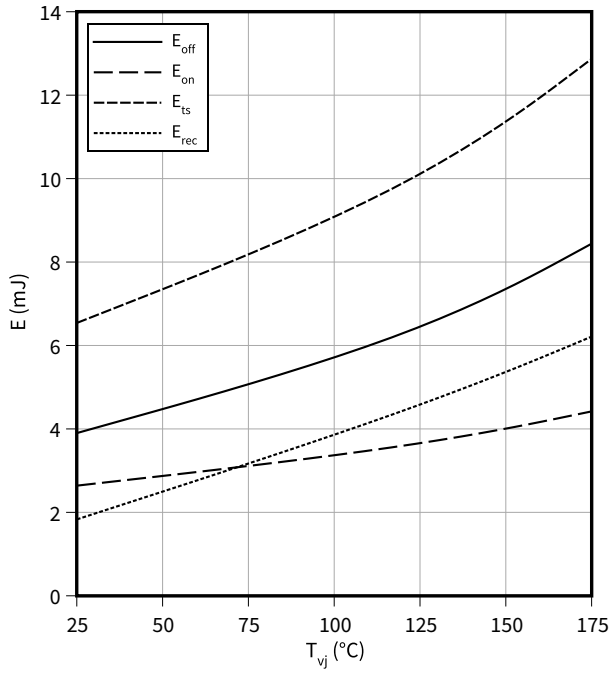
I_C = 140 A, V_{CC} = 600 V, T_{vj} = 175 °C, V_{GE} = 0/15 V



Typical switching energy losses as a function of junction temperature

$E = f(T_{vj})$

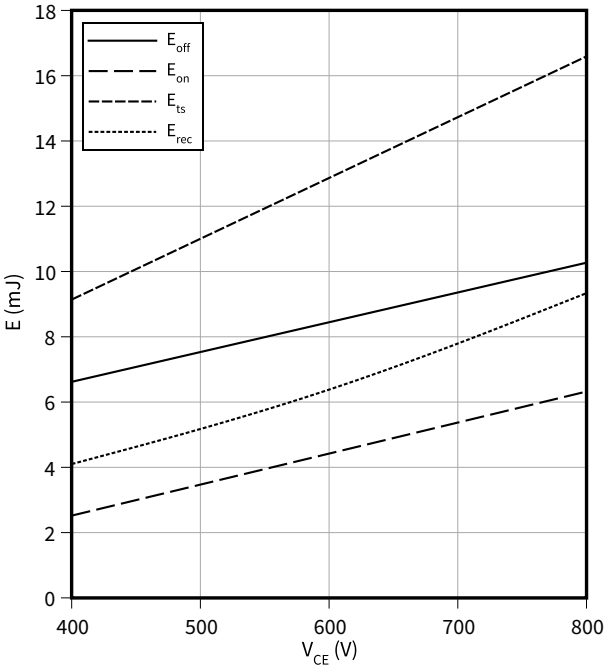
I_C = 140 A, V_{CC} = 600 V, V_{GE} = 0/15 V, R_G = 2.9 Ω



Typical switching energy losses as a function of collector emitter voltage

$E = f(V_{CE})$

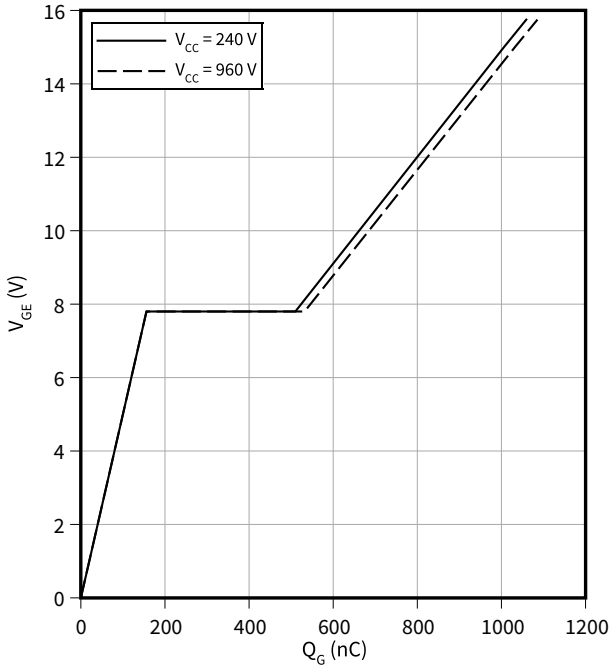
$I_C = 140\ A$, $V_{GE} = 0/15\ V$, $T_{vj} = 175\ °C$, $R_G = 2.9\ \Omega$



Typical gate charge

$V_{GE} = f(Q_G)$

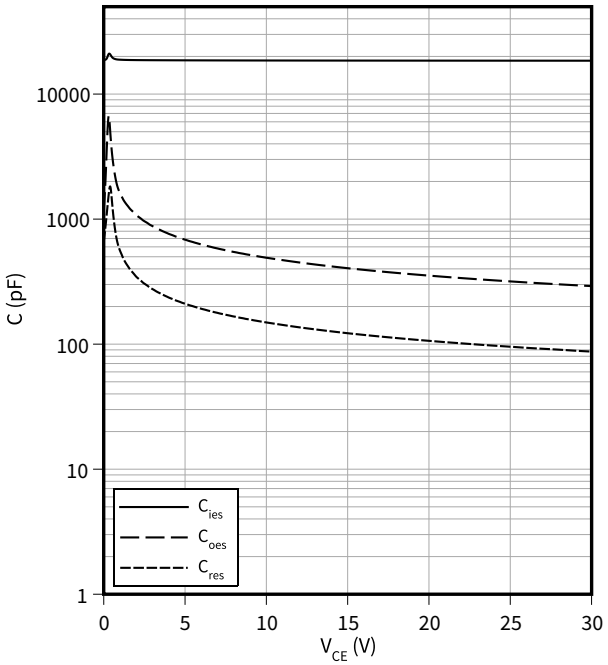
$I_C = 140\ A$



Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$

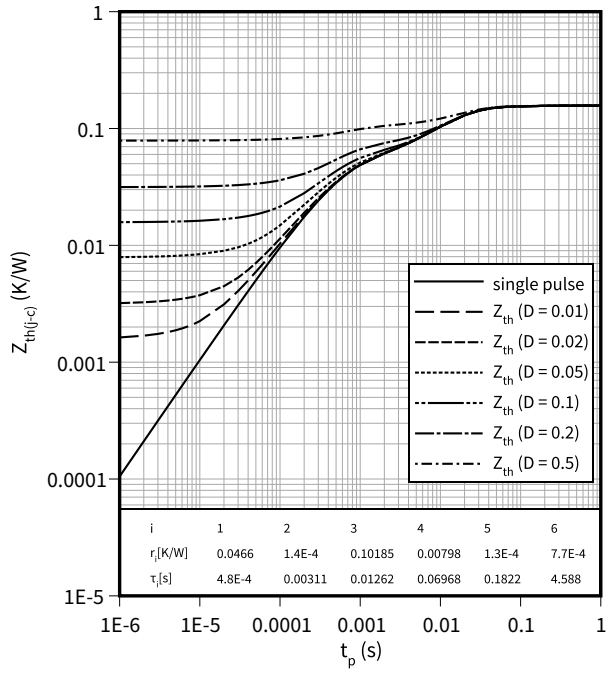
$f = 100\ kHz$, $V_{GE} = 0\ V$



IGBT transient thermal impedance as a function of pulse width

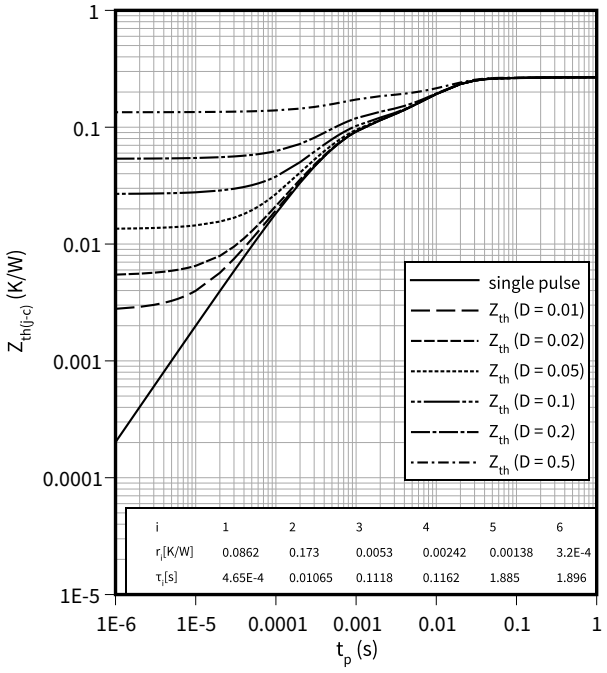
$Z_{th(j\text{-}c)} = f(t_p)$

$D = t_p/T$



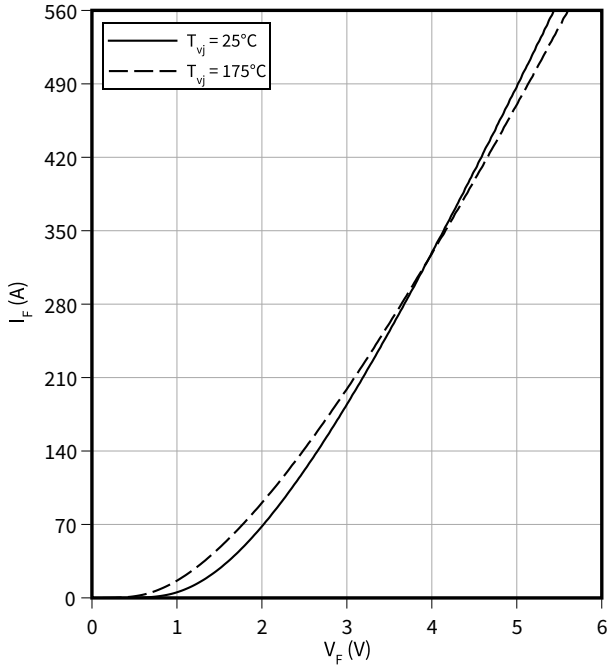
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
$D = t_p/T$



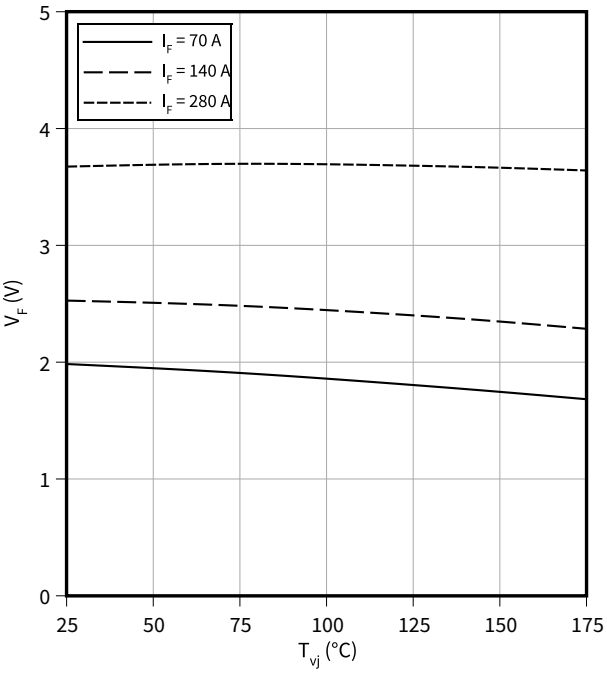
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



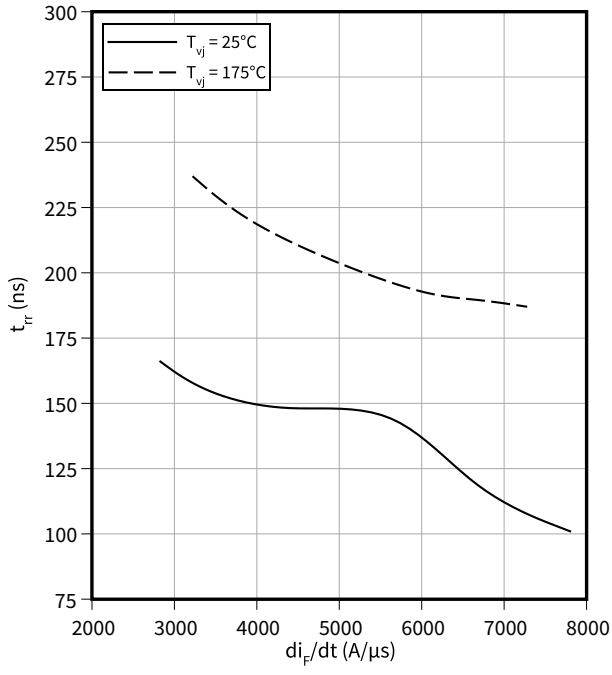
Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$



Typical reverse recovery time as a function of diode current slope

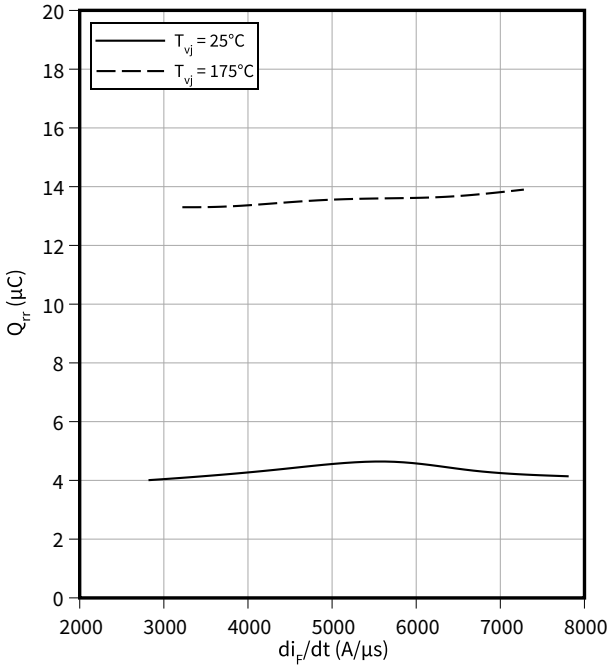
$t_{rr} = f(di_F/dt)$
V_R = 600 V, I_F = 140 A



Typical reverse recovery charge as a function of diode current slope

$Q_{rr} = f(di_F/dt)$

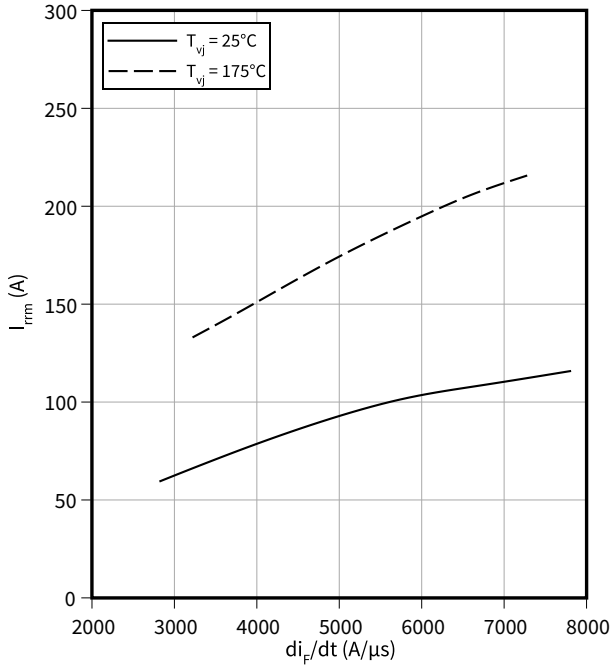
$V_R = 600\ V,\ I_F = 140\ A$



Typical reverse recovery current as a function of diode current slope

$I_{rrm} = f(di_F/dt)$

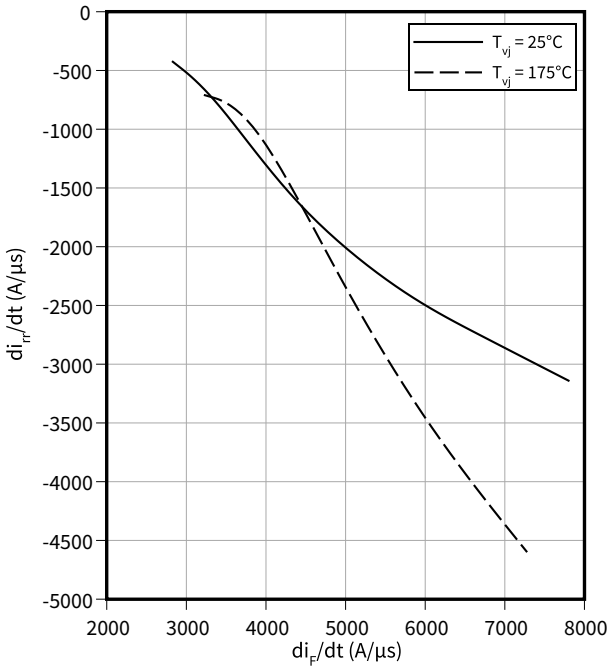
$V_R = 600\ V,\ I_F = 140\ A$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

$di_{rr}/dt = f(di_F/dt)$

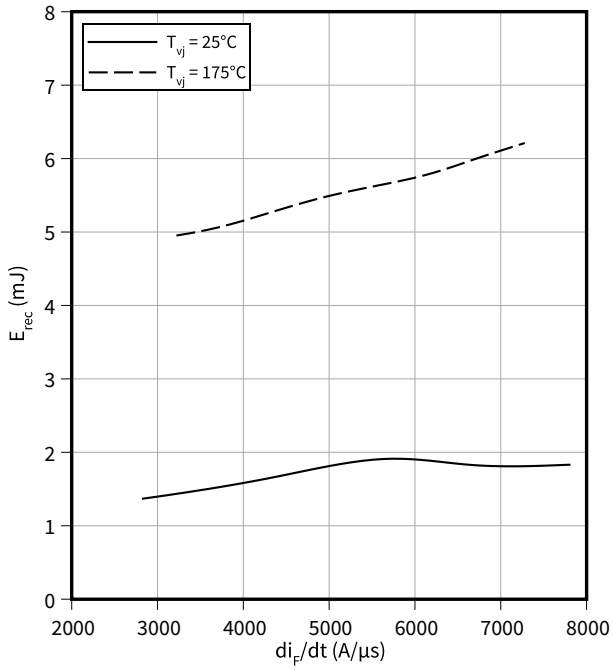
$V_R = 600\ V,\ I_F = 140\ A$



Typical reverse energy losses as a function of diode current slope

$E_{rec} = f(di_F/dt)$

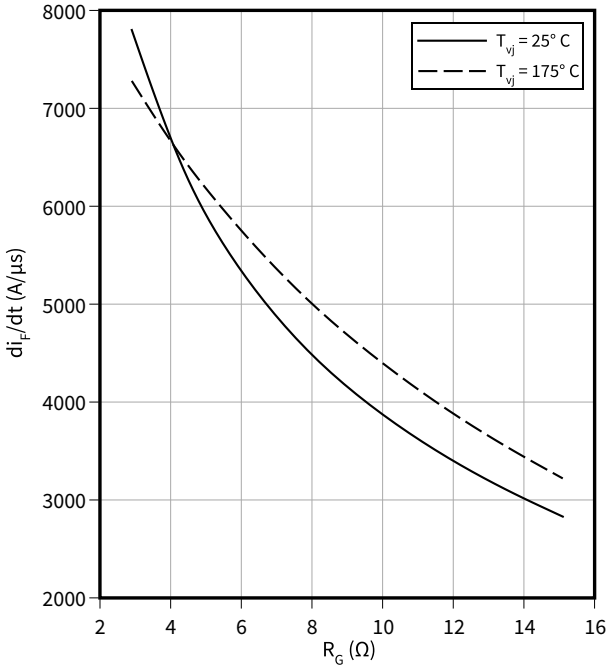
$V_R = 600\ V,\ I_F = 140\ A$



Typical diode current slope as a function of gate resistor

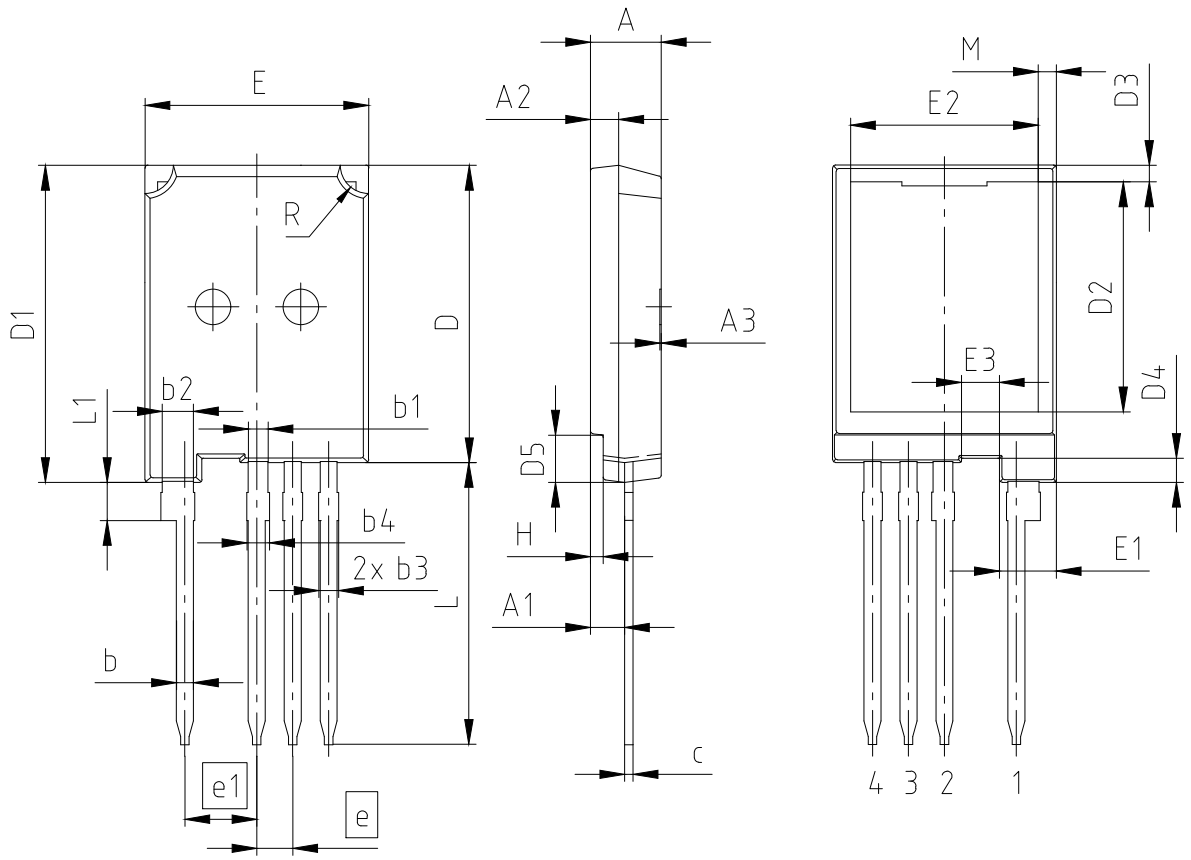
$di_F/dt = f(R_G)$

$V_R = 600$ V, $I_F = 140$ A



5 Package outlines

PG-TO247-4-PLUS-NN5.1



NOTES:
PACKAGE SURFACE ROUTE BETWEEN PIN 1 & PIN 2 WILL BE 5.1 mm MIN.
ALL b... AND c DIMENSIONS INCLUDING PLATING EXPECT AREA OF CUTTING

PACKAGE - GROUP NUMBER:	PG-TO247-4-U10				
DIMENSIONS	**MILLIMETERS**		**DIMENSIONS**	**MILLIMETERS**	
	MIN.	MAX.		MIN.	MAX.
A	4.90	5.10	**E**	15.70	15.90
A1	2.31	2.51	**E1**	3.90	4.10
A2	1.90	2.10	**E2**	13.10	13.50
b	1.16	1.29	**E3**	2.58	2.78
b1	1.36	1.49	**e**	2.54	
b2	2.16	2.29	**e1**	5.08	
b3	1.16	1.45	**H**	0.80	1.00
b4	1.16	1.65	**N**	4	
c	0.59	0.66	**L**	19.80	20.10
D	20.90	21.10	**L1**	2.55	2.85
D1	22.30	22.50	**M**	0.97	1.57
D2	15.95	16.55	**R**	1.90	2.10
D3	1.00	1.35			
D4	1.60	1.80			
D5	3.24	3.44			

Figure 1

6 Testing conditions

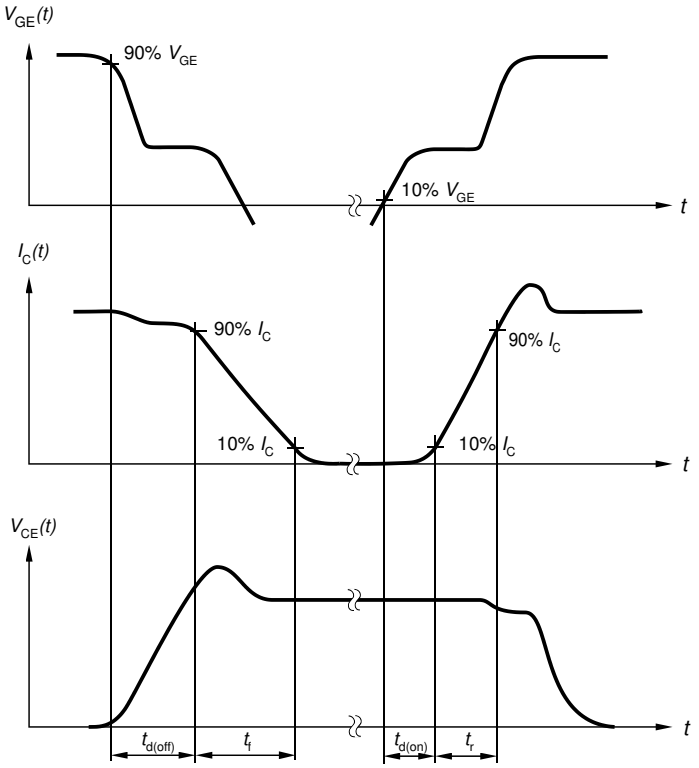


Figure A. **Definition of switching times**

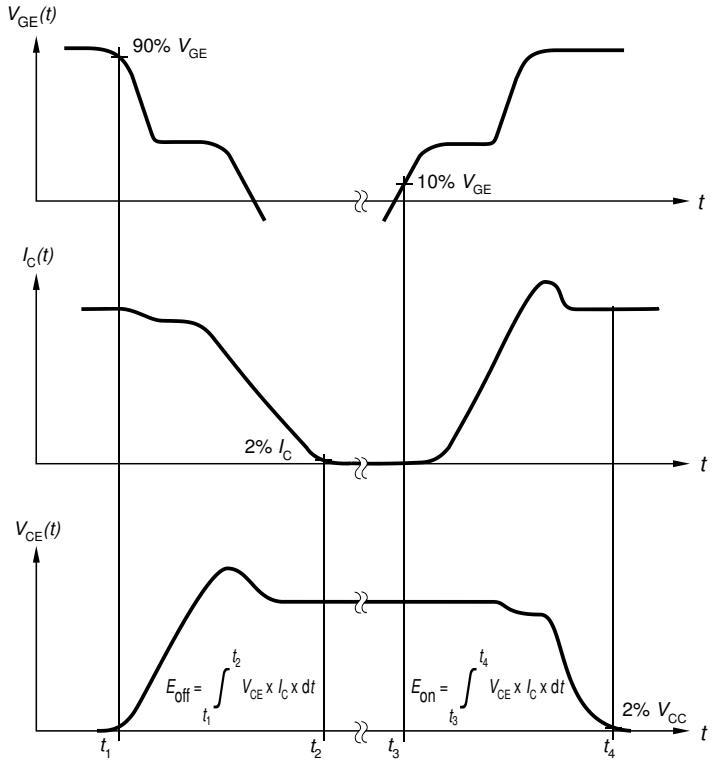


Figure B. **Definition of switching losses**

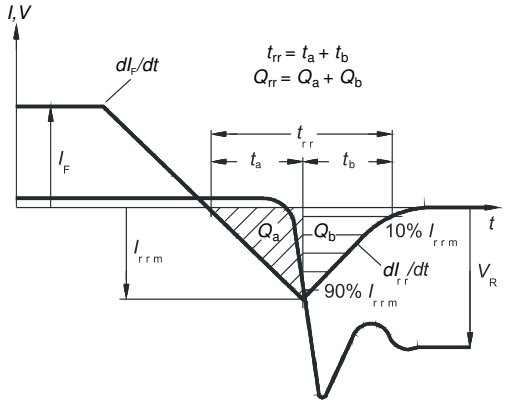


Figure C. **Definition of diode switching characteristics**

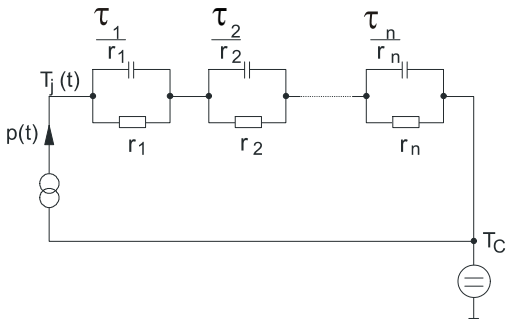


Figure D. **Thermal equivalent circuit**

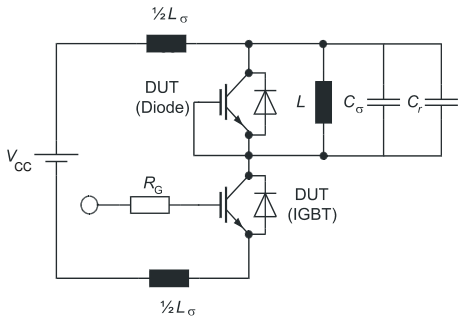


Figure E. **Dynamic test circuit**
Parasitic inductance L_σ,
parasitic capacitor C_σ,
relief capacitor C_r,
(only for ZVT switching)

Figure 2

Revision history

Document revision	Date of release	Description of changes
0.10	2022-05-02	Target datasheet
0.20	2022-05-19	Editorial changes
0.30	2022-06-01	Editorial changes
1.00	2022-11-29	Final datasheet
1.10	2023-01-17	Change of product outline drawing on page 14
1.20	2023-07-03	Figure on page 11 updated Editorial changes

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